

# Quad PLL Programmable Clock Generator with Spread Spectrum

#### **Features**

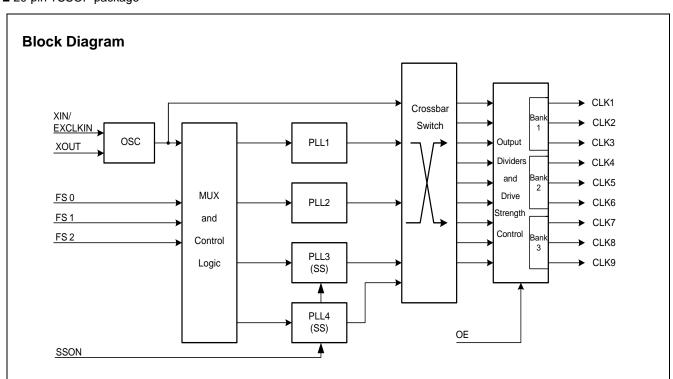
- Four fully integrated phase-locked loops (PLLs)
- Input frequency range
  - □ External crystal: 8 to 48 MHz
  - □ External reference: 8 to 166 MHz clock
- Wide operating output frequency range
  □ 3 to 166 MHz
- Programmable spread spectrum with center and down spread option and lexmark and linear modulation profiles
- Selectable V<sub>DD</sub> supply voltage options: 
  □ 2.5 V, 3.0 V, and 3.3 V
- Selectable output clock voltages, independent of V<sub>DD</sub> supply:

  □ 1.8 V, 2.5 V, 3.0 V, and 3.3 V
- Frequency select feature with option to select eight different frequencies over nine clock outputs
- Output enable, and SS ON/OFF controls
- Low jitter, high accuracy outputs
- Ability to synthesize nonstandard frequencies with Fractional-N capability
- Up to nine clock outputs with programmable drive strength
- Glitch-free outputs while frequency switching
- 20-pin TSSOP package

■ Commercial and Industrial temperature ranges

#### **Benefits**

- Multiple high performance PLLs allow synthesis of unrelated frequencies
- Nonvolatile programming for personalization of PLL frequencies, spread spectrum characteristics, drive strength, crystal load capacitance, and output frequencies
- Application specific programmable electromagnetic interference (EMI) reduction using spread spectrum for clocks
- Programmable PLLs for system frequency margin tests
- Meets critical timing requirements in complex system designs
- Suitability for PC, consumer, portable, and networking applications
- Capable of zero parts per million (PPM) frequency synthesis error
- Uninterrupted system operation during clock frequency switch
- Application compatibility in standard and low power systems For a complete list of related documentation, click here.





### Contents

General Description	4
Four Configurable PLLs	
Input Reference Clocks	4
V <sub>DD</sub> Power Supply Options	4
Output Bank Settings	4
Output Source Selection	4
Spread Spectrum Control	4
Frequency Select	4
Glitch-Free Frequency Switch	4
Output Enable Mode	
Output Drive Strength	4
Generic Configuration and Custom Frequency	4
Absolute Maximum Conditions	5
Recommended Operating Conditions	5
DC Electrical Specifications	6
Recommended Crystal Specification	
for SMD Package	7

Recommended Crystal Specification	
for Thru-Hole Package	7
AC Electrical Specifications	
Test and Measurement Setup	
Voltage and Timing Definitions	8
Ordering Information	
Possible Configurations	g
Ordering Code Definitions	g
Package Drawing and Dimensions	
Acronyms	
Document Conventions	11
Units of Measure	11
Document History Page	
Sales, Solutions, and Legal Information	
Worldwide Sales and Design Support	
Products	
PSoC Solutions	



VDD 1 20 CLK9 19 <sub>VSS</sub> XOUT 2 XIN/EXCLKIN 3 18 CLK8 VDD\_CLK\_B3 VSS 4 CLK1 5 16 CLK7/SSON CY25404 VDD\_CLK\_B1 6 15 VDD\_CLK\_B2 CLK2 7 CLK6 VSS 8 13 VSS CLK3/FS0 9 CLK5 OE/FS1 10 CLK4/FS2

Figure 1. Pin Diagram - CY25404 20 LD TSSOP

Table 1. Pin Definition - CY25404 ( $V_{DD}$  = 2.5 V, 3.0 V or 3.3 V Supply)

Pin Number	Name	Ю	Description
1	$V_{DD}$	Power	Power supply: 2.5 V/3.0 V/3.3 V
2	XOUT	Output	Crystal output
3	XIN/EXCLKIN	Input	Crystal Input or 1.8 V external clock input
4	V <sub>SS</sub>	Power	Power supply ground
5	CLK1	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B1 voltage
6	V <sub>DD</sub> _CLK_B1	Power	Power supply for Bank1, (CLK1, CLK2, CLK3) outputs: 1.8 V/2.5 V/3.0 V/3.3 V
7	CLK2	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B1 voltage
8	$V_{SS}$	Power	Power supply ground
9	CLK3/FS0	Output/Input	Multifunction programmable pin: Programmable clock output or frequency select input pin. Output voltage of CLK3 depends on V <sub>DD</sub> _CLK_B1 voltage
10	OE/FS1	Input	Multifunction programmable pin: High-true output enable or frequency select pin
11	CLK4/FS2	Output/Input	Multifunction programmable pin: Programmable clock output or frequency select input pin. Output voltage of CLK4 depends on V <sub>DD</sub> _CLK_B2 Voltage
12	CLK5	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B2 voltage
13	$V_{SS}$	Power	Power supply ground
14	CLK6	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B2 voltage
15	V <sub>DD</sub> _CLK_B2	Power	Power supply for Bank2, (CLK4, CLK5, CLK6) outputs: 1.8 V/2.5 V/3.0 V/3.3 V
16	CLK7/SSON	Output/Input	Multifunction programmable pin. Programmable clock output or spread spectrum On/OFF control input pin. Output voltage of CLK7 depends on V <sub>DD</sub> _CLK_B3 voltage
17	V <sub>DD</sub> _CLK_B3	Power	Power supply for Bank3, (CLK7, CLK8, CLK9) outputs: 1.8 V/2.5 V/3.0 V/3.3 V
18	CLK8	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B3 voltage
19	V <sub>SS</sub>	Power	Power supply ground
20	CLK9	Output	Programmable clock output. Output voltage depends on V <sub>DD</sub> _CLK_B3 voltage



### General Description

### Four Configurable PLLs

The CY25404 has four programmable PLLs that can be used to generate output frequencies ranging from 3 to 166 MHz. The advantage of having four PLLs is that a single device generates up to four independent frequencies from a single crystal.

#### Input Reference Clocks

The input to the CY25404 can be either a crystal or a clock signal. The input frequency range for crystals is 8 MHz to 48 MHz, while that for clock signals is 8 MHz to 166 MHz. The required voltage level for the input reference clock (EXCLKIN) is shown in the DC and AC Electrical Specification tables.

#### V<sub>DD</sub> Power Supply Options

This device has programmable power supply option and it can be programmed to operate at any voltage 2.5 V, 3.0 V, or 3.3 V.

#### **Output Bank Settings**

There are nine clock outputs grouped in three output driver banks. The Bank 1, Bank 2, and Bank 3 correspond to (CLK1, CLK2, CLK3), (CLK4, CLK5, CLK6), and (CLK7, CLK8, CLK9) respectively. Separate power supplies are used for each of these banks and they can be any of 1.8 V, 2.5 V, 3.0 V, or 3.3 V. These voltages are independent of  $\rm V_{DD}$  power supply used, giving user multiple choice of output clock voltage levels.

#### **Output Source Selection**

These devices have programmable input sources for each of its nine clock outputs (CLK1–9). There are five available clock sources for these outputs. These clock sources are: XIN/EXCLKIN, PLL1, PLL2, PLL3, or PLL4. Output clock source selection is done using four out of five crossbar switch. Thus, any one of these five available clock sources can be arbitrarily selected for the clock outputs. This gives user a flexibility to have up to four independent clock outputs.

#### **Spread Spectrum Control**

Two of the four PLLs (PLL3 and PLL4) have spread spectrum capability for EMI reduction in the system. The device uses a Cypress proprietary PLL and spread spectrum clock (SSC) technology to synthesize and modulate the frequency of the PLL. The spread spectrum feature can be turned on or off using a multifunction control pin (CLK7/SSON). It can be programmed to either center spread range from ±0.125% to ±2.50% or down spread range from -0.25% to -5.0% with Lexmark or Linear profile.

### **Frequency Select**

There are three multifunction frequency select pins (FS0, FS1 and FS2) that provide an option to select eight different sets of frequencies among each of the four PLLs. Each output has programmable output divider options.

#### **Glitch-Free Frequency Switch**

When the frequency select pin (FS) is used to switch frequency, the outputs are glitch-free provided frequency is switched using output dividers. This feature enables uninterrupted system operation while clock frequency is being switched.

### **Output Enable Mode**

There is a multifunction programmable pin 10, OE/FS1 that can be programmed to operate as output enable (OE) mode. OE is a high-true input and individual clock outputs can be programmed to be sensitive to this OE pin. If activated it shuts off the output drivers, resulting in minimum power consumption for the device.

#### **Output Drive Strength**

The DC drive strength of the individual clock output can be programmed for different values. Table 2 shows the typical rise and fall times for different drive strength settings.

Table 2. Output Drive Strength

Output Drive Strength	Rise/Fall Time (ns) (Typical Value)
Low	6.8
Mid Low	3.4
Mid High	2.0
High	1.0

#### **Generic Configuration and Custom Frequency**

There is a generic set of output frequencies available from the factory that can be used for the device evaluation purposes. The device, CY25404 can be custom programmed to any desired frequencies and listed features. For customer specific programming, please contact local cypress field application engineer (FAE) or sales representative.



### **Absolute Maximum Conditions**

Parameter	Description	Condition	Min	Max	Unit
$V_{DD}$	Supply voltage	-	-0.5	4.5	V
V <sub>DD_CLK_BX</sub>	Output bank supply voltage	-	-0.5	4.5	V
V <sub>IN</sub>	Input voltage	Relative to V <sub>SS</sub>	-0.5	V <sub>DD</sub> +0.5	V
T <sub>S</sub>	Temperature, storage	Non functional	-65	+150	°C
ESD <sub>HBM</sub>	ESD protection (human body model)	JEDEC EIA/JESD22-A114-E	2000		volts
UL-94	Flammability rating	V-0 at 1/8 in.	_	10	ppm
MSL	Moisture sensitivity level	-	3	}	

### **Recommended Operating Conditions**

Parameter	Description	Min	Тур	Max	Unit
$V_{DD}$	V <sub>DD</sub> operating voltage	2.25	_	3.60	V
V <sub>DD_CLK_BX</sub>	Output driver voltage for Bank 1, 2 and 3	1.71	_	3.60	V
T <sub>AC</sub>	Commercial ambient temperature	0	_	+70	°C
T <sub>AI</sub>	Industrial ambient temperature	-40		+85	°C
C <sub>LOAD</sub>	Maximum load capacitance	_	_	15	pF
t <sub>PU</sub>	Power-up time for all $V_{\text{DD}}$ to reach minimum specified voltage (power ramps must be monotonic)	0.05	_	500	ms

Notes
1. Guaranteed by design but not 100% tested.
2. Configuration dependent.



### **DC Electrical Specifications**

Parameter	Description	Conditions	Min	Тур	Max	Unit
V <sub>OL</sub>	Output low voltage	I <sub>OL</sub> = 2 mA, drive strength = [00]	-	1	0.4	V
		I <sub>OL</sub> = 3 mA, drive strength = [01]				
		I <sub>OL</sub> = 7 mA, drive strength = [10]				
		I <sub>OL</sub> = 12 mA, drive strength = [11]				
V <sub>OH</sub>	Output high voltage	I <sub>OH</sub> = -2 mA, drive strength = [00]	V <sub>DD_CLK_BX</sub> - 0.4	_	_	V
		I <sub>OH</sub> = -3 mA, drive strength = [01]	- 0.4			
		I <sub>OH</sub> = -7 mA, drive strength = [10]				
		I <sub>OH</sub> = -12 mA, drive strength = [11]				
V <sub>IL1</sub>	Input low voltage of FS0, OE/FS1, FS2, and SSON	-	-	_	0.2*V <sub>DD</sub>	V
V <sub>IL2</sub>	Input low voltage of EXCLKIN	-	_	_	0.18	V
V <sub>IH1</sub>	Input high voltage of FS0, OE/FS1, FS2, and SSON	-	0.8*V <sub>DD</sub>	-	-	V
$V_{IH2}$	Input high voltage of EXCLKIN	-	1.62	_	2.2	V
I <sub>IL1</sub>	Input low current of OE/FS1 pin	V <sub>IL</sub> = 0V	-	-	10	μΑ
I <sub>IH1</sub>	Input high current of OE/FS1 pin	$V_{IH} = V_{DD}$	-	_	10	μΑ
I <sub>IL2</sub>	Input low current of SSON, FS0 and FS2 pins	V <sub>IL</sub> = 0V (Internal pull dn = 160k typ)	-	_	10	μΑ
I <sub>IH2</sub>	Input high current of SSON, FS0, and FS2 pins	$V_{IH} = V_{DD}$ (Internal pull dn = 160k typ)	14	_	36	μΑ
R <sub>DN</sub>	Pull down resistor of SSON, FS0, and FS2 and off state (CLK1-CLK9) pins	Clock outputs in off-state by setting OE = Low	100	160	250	kΩ
I <sub>DD</sub> <sup>[1,2]</sup>	Supply current for CY25404	OE = High, No load	-	22	_	mΑ
C <sub>IN</sub> <sup>[1]</sup>	Input capacitance	SSON, CLKIN, FS0, OE/FS1, and FS2 pins	_		7	pF



### **AC Electrical Specifications**

Parameter	Description	Conditions	Min	Тур	Max	Unit
F <sub>IN</sub> (crystal)	Crystal frequency, XIN	-	8	_	48	MHz
F <sub>IN</sub> (clock)	Input clock frequency, EXCLKIN	-	8	_	166	MHz
F <sub>CLK</sub>	Output clock frequency	-	3	_	166	MHz
DC1	Output duty cycle, All clocks except Ref Out	Duty cycle is defined in Figure 3 on page 8; $t_1/t_2$ , measured at 50% of $V_{DD\_CLK\_BX}$	45	50	55	%
DC2	Ref out duty cycle	Ref In Min 45%, Max 55%	40	_	60	%
T <sub>RF1</sub> <sup>[1]</sup>	Output rise/fall time	Measured from 20% to 80% of V <sub>DD</sub> _CLK_BX, as shown in Figure 4 on page 8, C <sub>LOAD</sub> = 15 pF, Drive strength [00]	-	6.8	_	ns
T <sub>RF2</sub> <sup>[1]</sup>	Output rise/fall time	Measured from 20% to 80% of $V_{DD\_CLK\_BX}$ , as shown in Figure 4 on page 8, $C_{LOAD}$ = 15 pF, Drive strength [01]	-	3.4	-	ns
T <sub>RF3</sub> <sup>[1]</sup>	Output rise/fall time	Measured from 20% to 80% of V <sub>DD</sub> _CLK_BX, as shown in Figure 4 on page 8, C <sub>LOAD</sub> = 15 pF, Drive strength [10]	-	2.0	_	ns
T <sub>RF4</sub> <sup>[1]</sup>	Output rise/fall time	Measured from 20% to 80% of V <sub>DD</sub> _CLK_BX, as shown in Figure 4 on page 8, C <sub>LOAD</sub> = 15 pF, Drive strength [11]	-	1.0	_	ns
T <sub>CCJ</sub> <sup>[1,2]</sup>	Cycle-to-cycle jitter (peak)	Configuration dependent. See Table 3		100	_	ps
T <sub>LOCK</sub> <sup>[1]</sup>	PLL lock time	Measured from 90% of the applied power supply level	_	1	3	ms

Table 3. Configuration Example for C-C Jitter

Ref. Freq.	CLK1	Output	CLK2 Output		t CLK3 Output		CLK4 Output		CLK5 Output	
(MHz)	Freq. (MHz)	C-C Jitter Typ (ps)								
14.3181	8.0	134	166	103	48	92	74.25	81	Not Used	
19.2	74.25	99	166	94	8	91	27	110	48	75
27	48	67	27	109	166	103	74.25	97	Not Used	
48	48	93	27	123	166	137	166	138	8	103

### **Recommended Crystal Specification for SMD Package**

Parameter	Description		Range 2	Range 3	Unit
F <sub>IN</sub>	Crystal frequency	8 – 14	14 – 28	28 – 48	MHz
R1	Maximum motional resistance (ESR)	135	50	30	Ω
CL	Parallel load capacitance (device has internal load capacitance adjustment feature)		8 – 14	8 – 12	pF
DL(max)	Maximum crystal drive level	300	300	300	μW

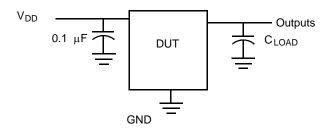
### **Recommended Crystal Specification for Thru-Hole Package**

Parameter	Description		Range 2	Range 3	Unit
F <sub>IN</sub>	Crystal frequency	8 – 14	14 – 24	24 – 32	MHz
R1	Maximum motional resistance (ESR)	90	50	30	Ω
CL	Parallel load capacitance (device has internal load capacitance adjustment feature)		8 – 12	8 – 12	pF
DL(max)	Maximum crystal drive level	1000	1000	1000	μW



### **Test and Measurement Setup**

Figure 2. Test and Measurement Setup



### **Voltage and Timing Definitions**

Figure 3. Duty Cycle Definition

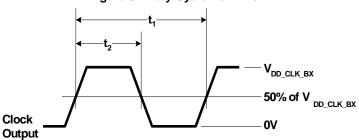
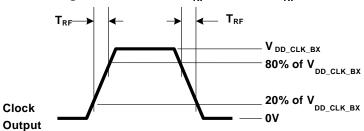


Figure 4. Rise Time =  $T_{RF}$ , Fall Time =  $T_{RF}$ 





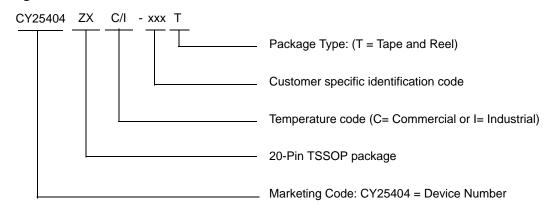
### **Ordering Information**

Some product offerings are factory programmed customer specific devices with customized part numbers. The Possible Configurations table shows the available device types, but not complete part numbers. Contact your local Cypress FAE or Sales representative for more information.

#### **Possible Configurations**

Part Number <sup>[3]</sup>	Туре	Production Flow
Pb-free	·	
CY25404ZXC-xxx	20-pin TSSOP	Commercial, 0 °C to 70 °C
CY25404ZXC-xxxT	20-pin TSSOP -Tape and Reel	Commercial, 0 °C to 70 °C
CY25404ZXI-xxx	20-pin TSSOP	Industrial, -40 °C to +85 °C
CY25404ZXI-xxxT	20-pin TSSOP -Tape and Reel	Industrial, -40 °C to +85 °C

#### **Ordering Code Definitions**



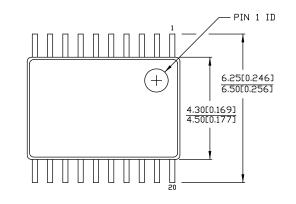
### Note

<sup>3.</sup> xxx indicates Factory Programmable and are factory programmed configurations. For more details, contact your local Cypress FAE or Cypress Sales Representative.



### **Package Drawing and Dimensions**

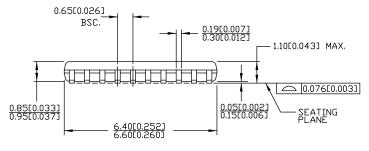
Figure 5. 20-LD TSSOP, Thin Shrunk Small Outline Package (4.40 mm Body) ZZ2

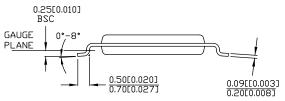


DIMENSIONS IN MM[INCHES] MIN. MAX.

REFERENCE JEDEC MO-153

PART #				
Z20.173	STANDARD PKG.			
ZZ20.173	LEAD FREE PKG.			





51-85118 \*E



### Acronyms

Acronym	Description
DL	drive level
EMI	electromagnetic interference
ESD	electrostatic discharge
FAE	field application engineer
FS	frequency select
JEDEC EIA	joint electron devices engineering council electronic industries alliance
OE	output enable
OSC	oscillator
PD	power-down
PLL	phase-locked loop
PPM	parts per million
SS	spread spectrum
SSC	spread spectrum clock
SSON	spread spectrum on
TSSOP	thin shrunk small outline package

### **Document Conventions**

### **Units of Measure**

Symbol	Unit of Measure
°C	degrees Celsius
fF	femtofarads
mA	milliampere
MHz	megahertz
μS	microseconds
ms	millisecond
μW	microwatts
ns	nanoseconds
pF	picofarads
ppm	parts per million
ps	picoseconds
V	volts
Ω	ohms
W	watts



### **Document History Page**

ocument Title: CY25404 Quad PLL Programmable Clock Generator with Spread Spectrum ocument Number: 001-43258					
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change	
**	1793805	See ECN	DPF/AESA	New data sheet	
*A	2748211	08/10/09	TSAI	Posting to external web.	
*B	2899300	03/26/2010	CXQ	Updated Ordering Information. Added note regarding Possible Configurations in Ordering Information section. Added Possible Configurations table for "xxx" parts. Updated Package Drawing and Dimensions	
*C	3308261	07/11/2011	BASH	Added Ordering Code Definitions Updated Package Drawing and Dimensions Added Acronyms Added Units of Measure Added Contents	
*D	4416418	06/30/2014	XHT	Added 1.8V for output clock voltage in page 1: Features Added 1.8V for Table 1: Pin Definition, V <sub>DD_CLK_B1</sub> , V <sub>DD_CLK_B2</sub> and V <sub>DD_CLK_B3</sub> Added 1.8V for General Description: Output Bank Settings Changed V <sub>DD_CLK_BX</sub> Min parameter from 2.25 to 1.71 Updated package drawing revision *D	
*E	4586478	03/12/2014	XHT	Added related documentation hyperlink in page 1. Updated package diagram 51-85118 to current revision.	



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CY25404ZXI009T CY25404ZXI-005T CY25404ZXI006T CY25404ZXI013T CY25404ZXI007 CY25404ZXI009

CY25404ZXI-003T CY25404ZXI-005 CY25404ZXI012 CY25404ZXI-003 CY25404ZXI217 CY25404ZXI217T

CY25404ZXI223 CY25404ZXI223T